SDAS002B - MARCH 1984 - REVISED DECEMBER 1994

 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

## description

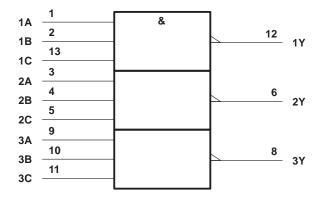
These devices contain three independent 3-input positive-NAND gates. They perform the Boolean functions  $Y = \overline{A} \bullet \overline{B} \bullet \overline{C}$  or  $Y = \overline{A} + \overline{B} + \overline{C}$  in positive logic.

The SN54ALS10A and SN54AS10 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS10A and SN74AS10 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

	INPUTS		OUTPUT
Α	В	С	Y
Н	Н	Н	L
L	X	Χ	н
Х	L	Χ	н
Х	X	L	Н

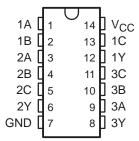
# logic symbol†



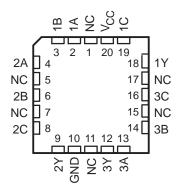
<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

#### SN54ALS10A, SN54AS10 . . . J PACKAGE SN74ALS10A, SN74AS10 . . . D OR N PACKAGE (TOP VIEW)

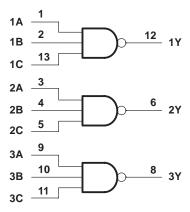


# SN54ALS10A, SN54AS10 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

## logic diagram (positive logic)



# SN54ALS10A, SN54AS10, SN74ALS10A, SN74AS10 TRIPLE 3-INPUT POSITIVE-NAND GATES

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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

# recommended operating conditions

		SN	SN54ALS10A		SN	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
.,	Low-level input voltage			0.8‡			0.8	V
VIL				0.7§				V
loh	High-level output current			-0.4			-0.4	mA
lOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C

<sup>‡</sup> Applies over temperature range -55°C to 70°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN	54ALS1	0A	SN	)A	UNIT	
PARAMETER			MIN	TYP¶	MAX	MIN	TYP¶	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{\parallel} = -18 \text{ mA}$			-1.5			-1.5	V
VOH	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2	2		V <sub>CC</sub> -2	2		V
VoL	V <sub>CC</sub> = 4.5 V	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	V
VOL.	VCC = 4.5 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5	V
Ι <sub>Ι</sub>	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 7 V			0.1			0.1	mA
lіН	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ
Ι <sub>ΙL</sub>	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.1			-0.1	mA
IO <sup>#</sup>	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-20		-112	-30		-112	mA
Іссн	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0		0.32	0.6		0.32	0.6	mA
ICCL	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 4.5 V		1.2	2.2		1.2	2.2	mA

<sup>¶</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>§</sup> Applies over temperature range 70°C to 125°C

<sup>#</sup>The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

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# switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>C</sub> C <sub>L</sub> R <sub>L</sub> T <sub>A</sub>	UNIT			
			SN54AI	LS10A	SN74AI	LS10A	
			MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	A, B, or C	V	2	12	2	11	ns
<sup>t</sup> PHL	A, B, OI C	1	2	12	2	10	115

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub>	7 V
Operating free-air temperature range, T <sub>A</sub> : SN54AS10	-55°C to 125°C
SN74AS10	0°C to 70°C
Storage temperature range	-65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions

		SN54AS10		SN74AS10			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	ONIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			0.8			0.8	V
ІОН	High-level output current			-2			-2	mA
loL	Low-level output current			20			20	mA
T <sub>A</sub>	Operating free-air temperature	-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		SI	N54AS1	0	S	N74AS1	0	UNIT
PARAMETER	lesi co	NUTTIONS	MIN	TYP§	MAX	MIN	TYP§	MAX	UNII
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{ } = -18 \text{ mA}$			-1.2			-1.2	V
Voн	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2	!		V <sub>CC</sub> -2	2		V
V <sub>OL</sub>	$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 20 \text{ mA}$		0.35	0.5		0.35	0.5	V
lį	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 7 V			0.1			0.1	mA
lін	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20			20	μΑ
I <sub>I</sub> L	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.5			-0.5	mA
ΙΟ <sup>¶</sup>	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-30		-112	-30		-112	mA
ICCH	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0		1.5	2.4		1.5	2.4	mA
ICCL	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 4.5 V		8.1	13		8.1	13	mA

<sup>§</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.



The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, Ios.

# SN54ALS10A, SN54AS10, SN74ALS10A, SN74AS10 TRIPLE 3-INPUT POSITIVE-NAND GATES

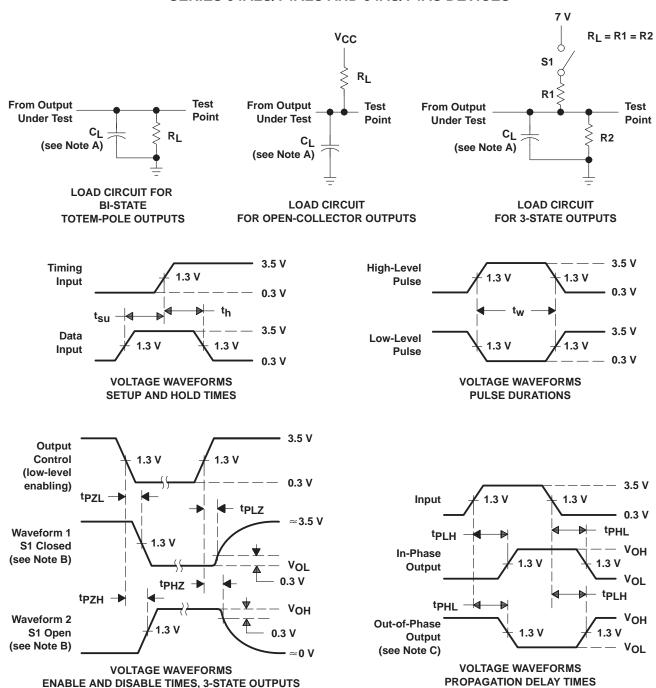
SDAS002B - MARCH 1984 - REVISED DECEMBER 1994

# switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC}$ = 4.5 V to 5.5 V, $C_L$ = 50 pF, $R_L$ = 500 $\Omega$ , $T_A$ = MIN to MAX $^{\dagger}$				UNIT
			SN54	AS10	SN74/	AS10	
			MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	A, B, or C	V	1	5	1	4.5	ns
<sup>t</sup> PHL	А, Б, ОГС	ſ	1	5	1	4.5	115

 $<sup>^\</sup>dagger$  For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_r = t_f = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms









#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-86865012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8686501CA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
5962-8686501DA	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
JM38510/37002B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/37002BCA	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN54ALS10AJ	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN54AS10J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SN74ALS10AD	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS10ADR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS10AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS10ANSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS10D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS10DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS10N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS10N3	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
SN74AS10NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54ALS10AFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS10AJ	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS10AW	ACTIVE	CFP	W	14	1	None	Call TI	Level-NC-NC-NC
SNJ54AS10FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS10J	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

None: Not yet available Lead (Pb-Free).

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(2)</sup> Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.



## PACKAGE OPTION ADDENDUM

28-Feb-2005

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